Winbond USB Scanner Processor

W6668F

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W6668F Data Sheet Revision History

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WINBOND USB SCANNER PROCESSOR

1. GENERAL DESCRIPTION

The W6668 is a highly integrated USB scanner control processor. It provides the system required signals for all necessary of a CCD/CIS scanner, the signal interface includes CCD/CIS sensor, image buffer memory, motor drive, lamp/LED drive and other mechanical input/output signals. The processor accept and process the analog image data, convert to digital data and store the data to the image buffer and then transfer to the host through USB bus. The scanner commands and status are transfer from or to the PC through USB bus without the aid of micro controller. The command and status also can be transfered through serial port and accessed by 8051 without the aids of USB port and windows operation system.

The only required additional active components are SRAM or DRAM for scanning image buffer, power regulator for 5V and 3.3V power source (if 3.3V component is in use) and power transistor array for the step motor.

2. FEATURES AND APPLICATIONS

Features:

Complete scanner on one chip solution for sheetfeed and flatbed scanners.

Internal timing generator for 300, 600 or 1200 dpi CCD/CIS sensor.

Builtin control signals for CCD lamp, CCD electric shutter, or CIS LED driver.

Multiple CCD transfer gate driver supported to extend CCD exposure time.

Exposure time of multiple CCD transfer gate driver can be programmed individually.

Horizontal and vertical of 1200, 800, 600, 400, 300, 200, 150, 100, 75 or 50 dpi selectable.

Three channels analog input with clamp circuit individually.

Integrated Correlated Double Sampler (CDS).

Integrated 6-bit Programmable Gain Amplifier (PGA) range from 1 to 6.

Integrated 8 + sign bits offset adjustment.

16-bit A/D Converter.

14-bit no missing Code Guaranteed.

24 MHz system clock and 1 MHz or 1.5 MHz or 2 MHz of pixel rate selectable by software reseting.

16-bit/8-bit image data capture.

R channel or G channel or B channel can be used in monochrome mode.

CIS LED light on overlap feature supported to get pure black and white monochrome scan.

Supports black and white of line art data format.

Direct access many types of SRAM/DRAM as image buffer.



32K. 64K. 128K. 256K or 512K with 8-bit data size of SRAM can be used.

64K, 256K, 1M or 4M with 8-bit or 16-bit data size of DRAM can be used.

Builtin shading and gamma correction process.

Shading and gamma process or gamma process only can be disabled.

8-bit or 16-bit of shading coefficient can be used.

8-bit or 14-bit of gamma coefficient can be used.

Full step, half step or micro step of step motor can be use.

Motor coil current can be fine tuned.

Support external bipolar PWM motor driver interface.

Motor speed can be selected from 2 times to 1/16 of exposure time each step.

0 to 255 back tracking step can be programmed.

Motor speed up and slow down with full, ½, ¼, 1/8 scan speed during scanning and back tracking.

Auto parking procedure supported.

Motor speed of scanning or auto-parking can be programmed individually.

CCD lamp PWM driver supported when external bipolar PWM motor driver is used.

LED indicator with on/off or 1/2 Hz, 1 Hz flash mode provided.

7-bit of general I/O port with latched and un-latched input port can be read.

Internal PLL provided to generate 48 MHz for USB SIE use.

Builtin USB transceiver, SIE and SIL processor.

Serial ROM interface for vendor ID and product ID code configuration.

USB Specification Version 1.1 Compliant.

High speed USB device with 12M bps data transmission rate.

Support suspend/resume mode, automatically/Host suspend and Host wake up (resume).

External wake up supported to wake up Host.

Support 1 device configuration and 1 device interface.

Support 4 endpoints includes:

Endpoint 0: Control transfer, 8 bytes packet size of bi-direction data transfer for device setup and configuration.

Endpoint 1: Bulk out transfer, 4 bytes or 8 bytes packet size of unidirection data transfer for scanner control command or scanner table download from Host to scanner.

Endpoint 2: Bulk in transfer, 64 bytes packet size double buffer of unidirection data transfer for scanner image data to Host. One or two bytes of unidirection data transfer for register data read or table read back to Host.

Endpoint 3: Interrupt transfer, 1 bytes packet size of unidirection data transfer for interrupt information to Host.

Bulid in USB 1.1 standard command decoder.



1.1 Mega byte transfer rate during image scan in.

Software USB driver for Win98 supported.

Support serial port access bypass USB interface.

Power saving mode supported.

CMOS compatible.

5 V analog and digital power required.

Builtin 5V to 3.3V regulator for the power source of internal logic and USB interface circuit.

100-pin PQFP package (W6668F).

Applications:

Flatbed Scanners.

Sheetfeed Scanners.

Film Scanners.

3. PIN CONFIGURATION

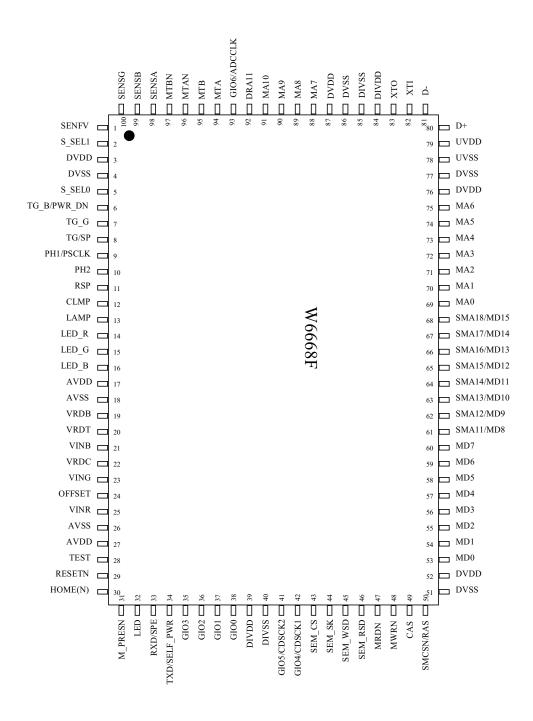


Fig.3-1 W6668F Pin Assignment.



4. PIN DESCRIPTIONS

Pin	Name	Туре	Description
		(mA)	
CCD/C	IS Interface:	T	
8	TG(_R)/SP	DO(4)	CCD Transfer Gate (R channel) or CIS Start Pulse.
7	TG_G	DO(4)	CCD Transfer Gate of G channel channel if three channel TG signal is enabled.
6	TG_B/ PWR_DN	DO(4) DI	CCD Transfer Gate of B channel channel if three channel TG signal is enabled. Power down or USB Suspend output, polarity setting during hardware reset, active low if set low at the end of hardware reset.
9	PH1/PSCLK	DO(4)	CCD Phase 1 clock or CIS pixel shift clock.
10	PH2	DO(4)	CCD Phase 2 clock.
11	RSP	DO(6)	CCD or CIS Reset Pulse.
12	CLMP	DO(4)	CCD Clamp or CIS Clamp.
14	LED_R	DO(2)	CIS red channel LED driver or CCD red channel electric shutter.
15	LED_G	DO(2)	CIS green channel LED driver or CCD green channel electric shutter.
16	LED_B	DO(2)	CIS blue channel LED driver or CCD blue channel electric shutter.
5	S_SEL0	DO(2)	CCD/CIS sensor channel Select 0.
	<u>SMTA</u>		Slave motor driver signal, positive A phase.
2	S_SEL1	DO(2)	CCD/CIS sensor channel Select 1.
	<u>SMTB</u>		Slave motor driver signal, positive B phase.
Analog	Signals Input:		
25	VINR	Al	Analog Input, R channel.
23	VING	Al	Analog Input, G channel.
21	VINB	Al	Analog Input, B channel.
Analog	Reference:		
20	VRDT	AO	ADC Reference Voltage (Top), top level of the ADC reference range.
19	VRDB	AO	ADC Reference Voltage (Bottom), bottom level of the ADC reference range.
22	VRDC	AO	ADC Reference Voltage (Internal), internal bias level of the ADC reference voltage.
24	OFFSET	AO/AI	Clamp Offset Voltage Output or offset voltage input in CIS mode.



4. Pin Description, continued

Pin	Name	Туре	Description
		(mA)	
Analog	Power:	II.	
17,27	AVDD	AP	Analog Power (2 pins).
18,26	AVSS	AP	Analog Ground (2 pins).
Image	Buffer Interface:		
75-69	MA[6:0]	DO(2)	Address line [8:0] of SRAM or address line [8:0] of DRAM.
91-88	MA[10:7]	DO(2)	Address line [10:9] of SRAM or address line [10:9] of DRAM.
92	DRA11/	DO(2)	Row address line 11 of DRAM.
	<u>SMTAN</u>		Slave motor driver signal, negative A phase.
68-61	SMA[18:11]/	DO/	Address line [18:11] of SRAM, high byte data bus of DRAM or data bus of
	MD[15:8]	DIO(2)	DRAM if 8-bit data is configured.
60-53	MD[7:0]	DIO(2)	Data bus of SRAM or low byte data bus of DRAM .
50	SMCSN/	DO(2)	Chip Select of SRAM or Raw address strobe of DRAM.
	RAS		
49	CAS	DO(2)	Column Address Strobe of DRAM.
47	MRDN	DO(2)	Memory Read control signal, active low.
48	MWRN	DO(2)	Memory Write control signal, also can be used as RD/WR signal of DRAM or SRAM, active low.
Motor	Control Driver S	ignal:	
94	MTA	DO(2)	Motor driver signal, positive A phase.
95	МТВ	DO(2)	Motor driver signal, positive B phase.
96	MTAN	DO(2)	Motor driver signal, negative A phase.
97	MTBN	DO(2)	Motor driver signal, negative B phase.
98	SENSA	Al	Motor phase A current sense input signal.
99	SENSB	Al	Motor phase B current sense input signal.
100	SENSG	Al	GND (reference) signal of motor phase current sense input.
1	SENFV	AI/AO	Full voltage of motor sense signal.



4. Pin Description, continued

Pin	Name	Туре	Description
		(mA)	
Serial I	ROM Interface:	-	
43	SEM_CS/	DO(2)	Serial EEPROM Chip Select.
	DFT_PDS3	DI	Default vendorID and product ID select bit 3.
44	SEM_SK/	DO(2)	Serial EEPROM Serial Clock.
	DFT_PDS2	DI	Default vendorID and product ID select bit 2.
45	SEM_WSD/	DO(2)	Serial EEPROM command Write Serial Data.
	DFT_PDS1	DI	Default vendorID and product ID select bit 1.
46	SEM_RSD/	DI	Serial EEPROM Read Serial Data.
	DFT_PDS0		Default vendorID and product ID select bit 0.
USB In	terface:		
80	D+	AIO	USB D plus signal.
81	D-	AIO	USB D minus signal.
Crysta	l Driver:		
82	XTI	DI	Clock driver input signal, may be used as external clock input.
83	хто	DO	Clock driver output signal.
I/O Sig	nals:		
30	HOME(N)	DI	Optical module home sensor, may be active high or active low.
32	LED	DO(2)	LED indicator.
13	LAMP	DO(2)	CCD Lamp driver, active high.
31	M_PRESN	DI	Manual Push button input, active low, also used as remote wake up input.
35-38	GIO[3:0]	DI/DO	General Input Output port [3:0].
		(2)	
42	GIO4/	DI/DO	General Input Output port 4 or AFE circuit CDSCK1 clock signal.
	CDSCK1	(2)	
41	GIO5/	DI/DO	General Input Output port 5 or AFE circuit CDSCK2 clock signal.
	CDSCK2	(2)	
93	GIO6/	DI/DO	General Input Output port 6 or AFE circuit ADCCLK clock signal.
	ADCCLK/	(2)	Slave motor driver signal, negative B phase.
	<u>SMTBN</u>		



4. Pin Description, continued

Pin	Name	Туре	Description
		(mA)	
Serial I	Port Signal:		
33	RXD/SPE	DI/DO	Receive Data pin or Serial Port Enable (high setting during reset), must left open when USB port is enabled.
34	TXD/	DO/DI	Transmit Data pin when serial port is enabled or device SELF Power
	SELF_PWR	(2)	configured if it is high when serial port is disabled.
Other 9	Signal:		
29	RESETN	DI	Reset input, hardware reset input, active low.
28	TEST	DI	Test Input, must left open in normal operation.
Power			
3,52,	DVDD	DP	Digital Power 5.0V (4 pins).
76,87			
4,51,	DVSS	DP	Digital Ground (4 pins).
77,86			
39,84	DIVDD	DP	Digital Internal Power 3.3V (2 pins).
40,85	DIVSS	DP	Digital Internal Ground (2 pins).
79	UVDD	AP	USB transceiver Power 3.3V.
78	UVSS	AP	USB transceiver Ground.

Type: AP is Analog Power, AI is Analog Input, AO is Analog Output, DP is Digital Power, DI is Digital Input, DO is Digital Output.



5. BLOCK DIAGRAM & REGISTERS LIST

5.1 Block Diagram

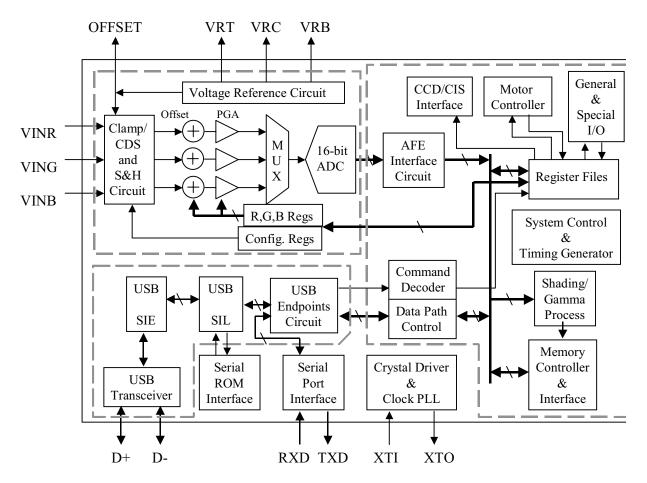


Fig. 5-1 Block Diagram of W6668 Device.

Note: Digital I/O pins are omitted on this figure.

There are three major parts consisted in W6668 device: the first part is analog front end circuit, at the left-top of the block diagram and is described in section 6; the second part is scanner ASIC circuit, at the right side of the block diagram and is described in section 7; the third part is USB interface circuit, at the left-bottom and is described in section 8. USB standard device requests is described in section 9. Figure 5-2 shows the image data processing flow from three channels analog input to USB bulk in to Host.

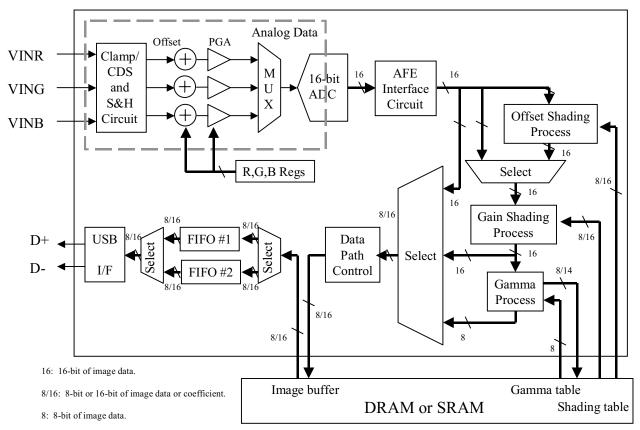


Fig. 5-2 Image Data Process Flow of W6668 Device.



5.2 Register List Tables

Part 1: Analog Front End

Addr	Name	Default				Con	tent			
(dec)		(hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
00H	Config Reg.	F8	IP_	Vref	3-ch	CDS	ICLB	AFE_	0	0
(0)			Span					PD		
01H	AFE MUX	C0	1	Mon_R	Mon_G	Mon_B	0	0	0	0
(1)	Reg.									
02H	PGA code	00	0	0	PGA_	PGA_	PGA_	PGA_	PGA_	PGA_
(2)	(R-ch)				R5	R4	R3	R2	R1	R0
03H	PGA code	00	0	0	PGA_	PGA_	PGA_	PGA_	PGA_	PGA_
(3)	(G-ch)				G5	G4	G3	G2	G1	G0
4H	PGA code	00	0	0	PGA_	PGA_	PGA_	PGA_	PGA_	PGA_
(4)	(B-ch)				B5	B4	В3	B2	B1	В0
05H	DAC code	00	DAC_							
(5)	(R-ch)		R7	R6	R5	R4	R3	R2	R1	R0
06H	DAC code	00	DAC_							
(6)	(G-ch)		G7	G6	G5	G4	G3	G2	G1	G0
07H	DAC code	00	DAC_							
(7)	(B-ch)		B7	В6	B5	B4	В3	B2	B1	В0
H80	DAC SIGN	00	0	0	0	0	0	0	0	DSIGN
(8)	(R-ch)									_R
09H	DAC SIGN	00	0	0	0	0	0	0	0	DSIGN
(9)	(G-ch)									_G
0AH	DAC SIGN	00	0	0	0	0	0	0	0	DSIGN
(10)	(B-ch)									_B



Part 2: CCD/CIS and AFE Interface

Addr	Name	Default				Con	tent			
(dec)		(hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
10H	Sensor	70	0	LEDB_	LEDG_	LEDR_	CLMP_	PH1_P	RS_P	TG_P
(16)	Signal Polarity			Р	Р	Р	Р			
11H	Phase	00	0	Diff_	Three_	NON_	ODD/	<u>PH_</u>	<u>PH_</u>	PH_EN
(17)	Behav Register			Exp_ MD	TG	DUTY	EVEN_ CCD	<u>QBL</u>	<u>DBL</u>	_TG
12H	Sensor	39	0	0	S_Bsel	S_Bsel	S_Gsel	S_Gsel	S_Rsel	S_Rsel
(18)	Channel Select				1	0	1	0	1	0
13H	TG shift	00	0	0	0	TG_	TG_	TG_	TG_	TG_
(19)	(note 1)					S4	S3	S2	S1	S0
14H	TG width	00	0	0	0	0	TG_	TG_	TG_	TG_
(20)	(note 2)						W3	W2	W1	W0
15H	RSP shift	00	0	0	0	RSP_	RSP_	RSP_	RSP_	RSP_
(21)	(note 1)					S4	S3	S2	S1	S0
16H	RSP width	00	0	0	0	RSP	RSP	RSP	RSP	RSP
(22)	(note 1)					_W4	_W3	_W2	_W1	_W0
17H	PH shift	00	0	0	0	PH_	PH_	PH_	PH_	PH_
(23)	(note 1)					S4	S3	S2	S1	S0
18H	CLMP shift	00	0	0	0	CLMP_	CLMP_	CLMP_	CLMP_	CLMP
(24)	(note 1)					S4	S3	S2	S1	_S0
19H	CLMP	00	0	0	0	CLMP_	CLMP_	CLMP_	CLMP_	CLMP
(25)	width					W4	W3	W2	W1	_W0
	(note 1)			_		27.01/	27.01/			25.011
1AH	CDSCK1	00	0	0	0	CDCK 1_S4	CDCK 1_S3	CDCK 1_S2	CDCK 1_S1	CDCK 1
(26)	shift					0.	00	02	0.	_S0
4511	(note 1)			00.01	00.017	0001		0001	0001	
1BH	CDSCK width	00	0	CDCK 2_W2	CDCK 2 W1	CDCK 2_W0	0	CDCK 1 W2	CDCK 1_W1	CDCK 1
(27)					*					wo
	(note 1)									_W(

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Part 2: CCD/CIS and AFE Interface, continued

Addr	Name	Default				Con	tent			
(dec)		(hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
1CH (28)	CDSCK2 shift (note 1)	00	0	0	0	CDCK 2_S4	CDCK 2_S3	CDCK 2_S2	CDCK 2_S1	CDCK 2 _S0
1DH (29)	Add_Fun_ Reg1	00	0	0	0	Mtr_no _Mv	2_Ph_ PWM	Algo_ Mtr_IF	Dumy_ TG	RSP_ Dis_T G
1EH (30)	Exposure time reg * (low byte)	ВС	EXP _T7	EXP _T6	EXP _T5	EXP _T4	EXP _T3	EXP _T2	EXP _T1	EXP _T0
1FH (31)	Exposure time reg * (high byte)	05	EXP _T15	EXP _T14	EXP _T13	EXP _T12	EXP _T11	EXP _T10	EXP _T9	EXP _T8
20H (32)	Start of LED R channel *	00	STRT _R7	STRT _R6	STRT _R5	STRT _R4	STRT _R3	STRT _R2	STRT _R1	STRT _R0
21H (33)	(low byte) Start of LED R channel * (high byte)	00	STRT _R15	STRT _R14	STRT _R13	STRT _R12	STRT _R11	STRT _R10	STRT _R9	STRT _R8
22H (34)	End of LED R channel * (low byte)	00	END _R7	END _R6	END _R5	END _R4	END _R3	END _R2	END _R1	END _R0
23H (35)	End of LED R channel * (high byte)	00	END _R15	END _R14	END _R13	END _R12	END _R11	END _R10	END _R9	END _R8
24H (36)	Start of LED G channel * (low byte)	00	STRT _G7	STRT _G6	STRT _G5	STRT _G4	STRT _G3	STRT _G2	STRT _G1	STRT _G0

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Part 2: CCD/CIS and AFE Interface, continued

Addr	Name	Default				Con	tent			
(dec)		(hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
25H	Start of LED G	00	STRT							
(37)	channel *		_G15	_G14	_G13	_G12	_G11	_G10	_G9	_G8
	(high byte)									
26H	End of LED	00	END							
(38)	G channel * (low byte)		_G7	_G6	_G5	_G4	_G3	_G2	_G1	_G0
27H	End of LED	00	END							
(39)	G channel * (high byte)		_G15	_G14	_G13	_G12	_G11	_G10	_G9	_G8
28H	Start of	00	STRT							
(40)	LED B channel *		_B7	_B6	_B5	_B4	_B3	_B2	_B1	_B0
	(low byte)									
29H	Start of	00	STRT							
(41)	LED B channel *		_B15	_B14	_B13	_B12	_B11	_B10	_B9	_B8
	(high byte)									
2AH	End of LED	00	END							
(42)	B channel * (low byte)		_B7	_B6	_B5	_B4	_B3	_B2	_B1	_B0
2BH	End of LED	00	END							
(43)	B channel * (high byte)		_B15	_B14	_B13	_B12	_B11	_B10	_B9	_B8



Part 3: Shading Gamma

Addr	Name	Default				Con	tent			
(dec)		(hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
2CH	Shad/gam	00	0	0	16-bit_	14-bit_	0	0	SH_	SH_
(44)	ma set Register				SHAD	Gamm			GM_	GM_
	register					а			EN1	EN0
2DH	Start	00	0	0	SSDG	SSDG	SSDG	SSDG	SSDG	0
(45)	Shd_Gm_ Address				_ 	_AD_2 0	_AD_1 9	_AD_1 8	_AD_1 7	
	Reg				AD_21					
2EH	Start G-ch	00	STO_	STO_	STO_	STO_	0	0	0	0
(46)	Offset Reg		G11	G10	G9	G8				
2FH	(low byte) Start G-ch	00	0	0	0	STO_	STO_	STO_	STO_	STO_
(47)	Offset Reg	00	U	U	0	G16	G15	G14	G13	G12
(47)	(high byte)					010	010	014	010	012
30H	Start B-ch	00	STO_	STO_	STO_	STO_	0	0	0	0
(48)	Offset Reg		B11	B10	В9	B8				
	(low byte)			_	_					
31H	Start B-ch Offset Reg	00	0	0	0	STO_	STO_	STO_	STO_	STO_
(49)	(high byte)					B16	B15	B14	B13	B12
32H	Start R-ch	00	STG_	STG_	STG_	STG_	0	0	0	0
(50)	Gain Reg		R11	R10	R9	R8				
	(low byte)									
33H	Start R-ch Gain Reg	00	0	0	0	STG_	STG_	STG_	STG_	STG_
(51)	(high byte)					R16	R15	R14	R13	R12
34H	Start G-ch	00	STG	STG	STG_	STG	0	0	0	0
(52)	Gain Reg		G11	G10	G9	G8				
(-)	(low byte)									
35H	Start G-ch	00	0	0	0	STG_	STG_	STG_	STG_	STG_
(53)	Gain Reg					G16	G15	G14	G13	G12
2011	(high byte)	00	0.7.0	0.7.0	0.7.0	OTO	0		0	
36H (54)	Start B-ch Gain Reg	00	STG_ B11	STG_ B10	STG_ B9	STG_ B8	0	0	0	0
(54)	(low byte)		DII	БЮ	D9	Dŏ				

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PRELIMINARY

Part 3: Shading Gamma, continued

Addr	Name	Default				Con	tent			
(dec)		(hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
37H	Start B-ch	00	0	0	0	STG_	STG_	STG_	STG_	STG_
(55)	Gain Reg					B16	B15	B14	B13	B12
	(high byte)									
38H	Start_Img	00	STI_	STI_	STI_	STI_	0	0	0	0
(56)	Reg		AD11	AD10	AD9	AD8				
, ,	(low byte)									
39H	Start_Img	00	0	0	0	STI_	STI_	STI_	STI_	STI_
(57)	Reg					AD16	AD15	AD14	AD13	AD12
` ′	(high byte)									

Part 4: Motor Control

Addr	Name	Default				Con	itent			
(dec)		(hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
ЗАН	Motor	00	AUTO	<u>MTR</u>	<u>DUAL</u>	Mtr_C_	Micro	M_Full	MTR	MTR
(58)	behav register		_PK	<u>DRV_S</u>	<u>MTR</u>	Ctrl	_step	_step	_2PH	_CDIR
3BH	Motor	00	0	MTPK	MTPK	MTPK	0	MTS	MTS	MTS
(59)	speed register			_SP2	_SP1	_SP0		_SP2	_SP1	_SP0
3CH	Motor	00	PWM_	PWM_	PWM_	PWM_	PWM_	PWM_	PWM_	PWM_
(60)	PWM_P register		FC_7	FC_6	FC_5	FC_4	FC_3	FC_2	FC_1	FC_0
3DH	Motor	00	0	0	PWM_	PWM_	PWM_	PWM_	PWM_	PWM_
(61)	PWM_D register				DC_5	DC_4	DC_3	DC_2	DC_1	DC_0
3EH	Motor	00	1/4_	1/4_	1/4_	1/4_	1/2_	1/2_	1/2_	1/2_
(62)	speed up register 1		STP_3	STP_2	STP_1	STP_0	STP_3	STP_2	STP_1	STP_0
3FH	Motor	00	0	0	0	0	1/8_	1/8_	1/8_	1/8_
(63)	speed up register 2						STP_3	STP_2	STP_1	STP_0
40H	Motor	00	0	0	0	0	Mtr_	Mtr_	Mtr_	Mtr_
(64)	pause step register						PS_3	PS _2	PS_1	PS _0
41H	Back	00	BKTR	BKTR	BKTR	BKTR	BKTR	BKTR	BKTR	BKTR
(65)	tracking reg.		7	6	5	4	3	2	1	0



Part 5: Image Buffer, Line Art and Shading Process and Scanning Area

Addr	Name	Default				Con	tent			
(dec)		(hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
42H	Memory	80	DRAM	0	0	MDS	0	ADDL	ADDL	ADDL
(66)	type register					-16		_2	_1	_0
43H	Line art	00	LART_							
(67)	Threshold register		TH7	TH6	TH5	TH4	TH3	TH2	TH1	TH0
44H	Img LL Th	00	lmg_	Img_						
(68)	register		LLT _7	LLT _6	LLT _5	LLT _4	LLT _3	LLT _2	LLT _1	LLT _0
45H	Img FML	00	lmg_	Img_	Img_	Img_	Img_	Img_	Img_	lmg_
(69)	register		FML _7	FML _6	FML _5	FML _4	FML _3	FML _2	FML _1	FML _0
46H	Start point	00	STRT							
(70)	of shading reg (low byte)		_SDN7	_SDN6	_SDN5	_SDN4	_SDN3	_SDN2	_SDN1	_SDN0
47H	Start point	00	0	0	0	0	STRT	STRT	STRT	STRT
(71)	of shading reg (high						_SDN	_SDN	_SDN9	_SDN8
	byte)						11	10		
48H	Start point	00	STRT							
(72)	of x-axis reg (low byte)		_X7	_X6	_X5	_X4	_X3	_X2	_X1	_X0
49H	Start point	00	0	0	STRT	STRT	STRT	STRT	STRT	STRT
(73)	of x-axis reg (high byte)				_X13	_X12	_X11	_X10	_X9	_X8
4AH	End point of	00	END							
(74)	x-axis reg (low byte)		_X7	_X6	_X5	_X4	_X3	_X2	_X1	_X0
4BH	End point of	00	0	0	END	END	END	END	END	END
(75)	x-axis reg (high byte)				_X13	_X12	_X11	_X10	_X9	_X8



Part 5: Image Buffer, Line Art and Shading Process and Scanning Area, continued

Addr	Name	Default				Cor	tent			
(dec)		(hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
4CH (76)	Start point of y-axis	00	STRT _Y7	STRT _Y6	STRT Y5	STRT _Y4	STRT _Y3	STRT _Y2	STRT _Y1	STRT _Y0
(70)	reg (low byte)		-	_10	_10	_14	_10	_12	_''	_10
4DH	Start point	00	STRT	STRT	STRT	STRT	STRT	STRT	STRT	STRT
(77)	of y-axis reg (high byte)		_Y15	_Y14	_Y13	_Y12	_Y11	_Y10	_Y9	_Y8
4EH	End point of	00	END	END	END	END	END	END	END	END
(78)	y-axis reg (low byte)		_Y7	_Y6	_Y5	_Y4	_Y3	_Y2	_Y1	_Y0
4FH	End point of	00	END	END	END	END	END	END	END	END
(79)	y-axis reg (high byte)		_Y15	_Y14	_Y13	_Y12	_Y11	_Y10	_Y9	_Y8

Part 6: System Control

Addr	Name	Default				Con	tent			
(hex)		(hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
50H	Modes	00	0	SHUT_	COL_	COL_	0	L_ART	SPEE	PIX_
(80)	configure register			OVLP	TYP1	TYP0			D_MD	MD
51H	X-	00	0	0	AFE_	AFE_	REXL	REXL	REXL	REXL
(81)	resolution register				DS1	DS0	_X3	_X2	_X1	_X0
52H	Y-resolution	00	0	0	0	0	REXL	REXL	REXL	REXL
(82)	register						_Y3	_Y2	_Y1	_Y0
5CH	Command	00	ABRT_	RESE	MCKS	MCKS	0	PARK	STRT_	STRT_
(92)	register		SCN	T	_1	_0			NSCN	SCN



Part 7: General I/O and Special Registers

Addr	Name	Default				Con	tent			
(dec)		(hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
5EH (94)	General IO direction register 1	0F	LTHP3	LTHP2	LTHP1	LTHP0	GDR3	GDR2	GDR1	GDR0
5FH (95)	General IO direction register 2	07	0	LTHP6	LTHP5	LTHP4	0	GDR6	GDR5	GDR4
60H (96)	General IO register 1	00	LTHI3	LTHI2	LTHI1	LTHI0	GIO3	GIO2	GIO1	GIO0
61H (97)	General IO register 2	00	0	LTHI6	LTHI5	LTHI4	0	GIO6	GIO5	GIO4
62H (98)	Special_IP register	00	0	0	0	0	0	HOME	LTH_M - PRES	M_ PRES
63H (99)	LL_driver register	04	CCD_ LPON	0	LEDI_ ST1	LEDI_ ST0	SIG_O _ON	HOME _P	0	0
64H (100)	Interrupt enable register	00	Buffer_ FUL	EOS	HOME	LTH_M - PRES	LTHI3	LTHI2	LTHI1	LTHI0
65H (101)	Interrupt clear register	00	Buffer_ FUL	EOS	HOME	LTH_M - PRES	LTHI3	LTHI2	LTHI1	LTHI0
66H (102)	Add_Fun_ Reg2	00	LAMP_ PWM	0	0	0	0	0	0	0



6. SCANNER ASIC CIRCUIT

Scanner ASIC circuit services USB command from USB interface circuit, decodes the commands, control the scanner system and generates timing for CCD/CIS interface, AFE circuit, image buffer memory, motor control and other I/O interface. The image data converted by 16-bit ADC in AFE circuit is buffered in AFE interface circuit, the data will write to image buffer memory and finally transfered to the double FIFO in the USB interface circuit. The reference clock of scanner ASIC circuit is MCLK and is derived from 24 MHz crystal clock and 48 MHz of internal PLL output clock.

6.1 Command Decoder and Interrupt

The USB interface will be enabled if the RXD/SPE pin is low. The detail of USB bulk out, bulk in and interrupt in transaction refer to section 9, the address and data definition are listed in each bit content and address mapping tables.

There are four bytes of Host command: command code, address/index_high, data/index_low and extend byte.

Command Code:

Bit [1:0], select which channel of table access.

Bit [1:0] = 00: R-channel.

01: G-channel.

10: B-channel.

11: reserved.

Bit [3:2], select which table to be accessed.

Bit [3:2] = 00: reserved.

01: Offset shading table.

10: Gain shading table.

11: gamma table.

Bit [5:4], reserved (must set to 00).

Bit 6 = 1: table access.

0: register access.

Bit 7, read/write action.

Bit 7 = 1: register or table read.

0: register/command write or table download.



Address/Index_high

Defines:

- 1. Register address.
- 2. Table index bit [15:8] of read table action.

Data/Index_low

Defines:

- 1. Data of register write.
- 2. Table index bit [7:0] of read table action. 00H is the start byte (or word) of the table, 01H is the next content byte (or word) the table.

Extend Byte:

Reserved.

Command Type

Software Reset

The software reset write from Host are via USB bulk out transaction at USB endpoint 1, this command will force to reset the USB command interface and scanner ASIC circuit, the system clock of scanner ASIC and enable/disable of internal 5V to 3.3V regulator also can be configured during software reset. This command must activated before any registers programmed.

- 1. Code byte = 00H.
- 2. Address byte, the address must be (5CH).
- 3. Data byte, the data must be any one of 40H, 48H, 50H, 58H, 60H or 68H.

40H when system clock is 24M, 50H when system clock is 36M, 60H when system clock is 48M, internal 5V to 3.3V power regulator can be disabled by set bit 3 to high.

4 Extend byte, reserved.

Table Download Command

The table may be offset/gain or gamma of R, G or B channel. The data length of shading table and gamma table is configured in shading/gamma set register. The following bulk out commands must be 8 bytes packet size to download the table, the bulk out command with zero length or less than 8 bytes must activated to end the table download.

- 1. Command code byte: 4XH, bit [3:0] select which channel of which table to be down-loaded.
- 2. Address, this byte is ignored.
- 3. Data byte, this byte is ignored.
- 4. Extend byte, reserved.



Table Read Command

The table may be offset/gain or gamma of R, G or B channel. The data length of shading table and gamma table is configured in shading/gamma set register. The following bulk in command has two byte to be read if the data length over 8 bits.

- 1. Command code byte: CXH, bit [3:0] select which channel of which table to be read.
- 2. Index high byte: high byte of the table index.
- 3. Index low byte: low byte of the table index.
- 4. Extend byte, reserved.

The USB bulk in transaction for data read in are listed as follows:

- 1. Data byte or data high byte.
- 2. Data low byte, when the data length of the read table is over 8 bits.

Register or Command Write

The register write or command write from Host are via USB bulk out transaction at USB endpoint 1. The USB bulk out transaction for register or command write are listed as follows:

- 1. Code byte = 00H.
- 2. Address byte:

Bit [7:0], defines the register address map of the W6668.

3. Data byte:

Bit [7:0], is the data to be write to the assigned register.

4. Extend byte, reserved.

Register Read

There are two stages for the register read access, the first stage is read command and register address activates from Host through USB bulk out transaction at USB endpoint 1 and the second stage is the data read in via USB bulk in transaction at USB endpoint 2. The start scan, start no scan and park command also can be read back to check the command is processing or finished. The USB bulk out transaction for register read are listed as follows:

- 1. Code byte = 80H.
- 2. Address byte:

Bit [7:0], defines the register address map of the W6668.

3. Data byte:

Bit [7:0], is ignored during read.

4. Extend byte, reserved.

The USB bulk in transaction for data read in are listed as follows:

1. Data byte, data content to be read



Scan Command and Image Data In

The image data in command from Host are via USB bulk out transaction at USB endpoint 1. The USB bulk out transaction for scan command and image data in are listed as follows:

- 1. Code byte = 00H.
- 2. Address byte:

The address must be (5CH).

3. Data byte:

The data must be 01H.

4. Extend byte, reserved.

The image data in to Host are via USB bulk in transaction at USB endpoint 2.

Abort Scan Command Write

The abort scan command write from Host are via USB bulk out transaction at USB endpoint 1, this command will force to transmit the abort scan command from Host to scanner ASIC circuit even if the image data in transaction is going on.

- 1. Code byte = 00H.
- 2. Address byte:

The address must be (5CH).

3. Data byte:

The data must be 80H.

4. Extend byte, reserved.

Interrupt In

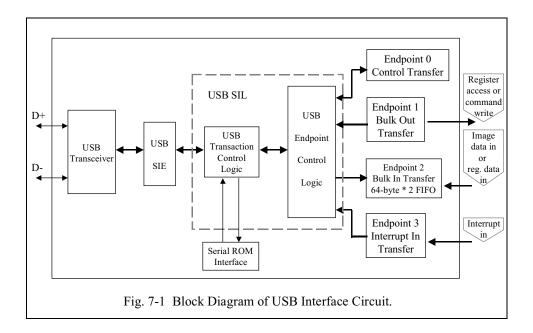
The data length of interrupt in is one byte, the USB interrupt transaction will be activated if any bit changing from low to high, the interrupt source can be masked (disabled) if write 0 to the related bit in the interrupt enable register. The content of the interrupt in is:

- Bit [3:0]: Latched GIO[3:0] pin, when the signal of LTHI[3:0] bits in General IO register is set.
- Bit 4: Latched M_PRES, when the signal of LTH_M_PRES bit in Special IP register is set.
- Bit 5: HOME, active when the optical module has been back to home position.
- Bit 6: End of Scan, this bit will issue interrupt if the scan command or start no scan command has been processed completely.
- Bit 7: Image buffer full, the motor will stop scan forward and interrupt will be activated with this bit high.



7. USB INTERFACE CIRCUIT

USB interface circuit includes USB transceiver, USB serial interface engine (SIE), USB transaction control logic, USB endpoint control logic and endpoint circuit. The USB transaction control logic and USB endpoint control logic also called USB serial interface logic (SIL). Figure 7-1 shows the detail block diagram of USB interface circuit.



USB transceiver accept analog USB D+ and D- signal from USB Host or USB Hub. The internal digital data stream is converted from the USB D+ and D- and the USB bus state of connect, disconnect, idle, resume and reset are also recognized by the USB transceiver. USB transceiver accept transmit data stream from SIE, convert to analog USB D+ and D- signal and transmit to USB Host or USB Hub. Figure 7-2and 7-3 show the analog eye pattern of USB D+ and D- waveform with 1M of USB cable and 5M of USB cable.

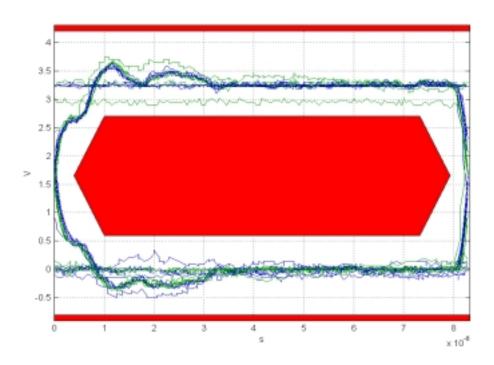


Figure 7-2 Eye Pattern of USB D+ and D- Signals with 1M of USB Cable.

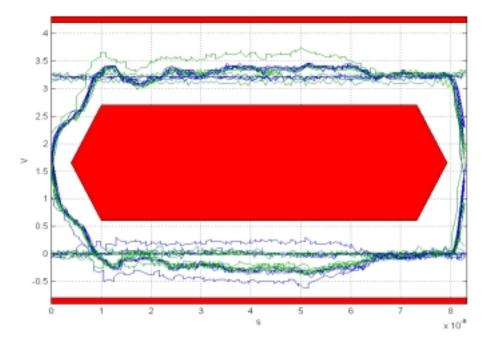


Figure 7-3 Eye Pattern of USB D+ and D- Signals with 5M of USB Cable.



Serial interface engine (SIE) accept the serial data stream from USB transceiver, recognize packet boundary, convert to parallel data and transfer to SIL circuit. The transmit data also converted to serial data stream, packeted and transfered to USB transceiver.

USB serial interface logic (SIL) is consisted of USB transaction control logic and USB endpoint control logic. There are four endpoints consisted in USB interface circuit. Endpoint 0 is control transfer, the transaction is 8 bytes packet size of bi-direction data transfer for device setup and configuration. Endpoint 1 is bulk out transfer, the transaction is 4 bytes packet size of unidirection data transfer for scanner control command from Host to scanner, another transaction is 8 bytes packet size of unidirection data transfer for shading and gamma table download from Host to scanner. Endpoint 2 is bulk in transfer, the main transaction is 64 bytes packet size double buffer of unidirection data transfer for scanner image data to Host, another transaction is one byte of unidirection data transfer for register data read back to Host or one or two bytes of unidirection data transfer for shading and gamma table data read back to Host. There are two 64-byte FIFO in the endpoint 2 circuit and are used to buffered the image data between image buffer memory and USB bulk in transaction. Endpoint 3 is interrupt transfer, the transaction is 1 bytes packet size of unidirection data transfer for interrupt information to Host.

7.2 Serial ROM Access

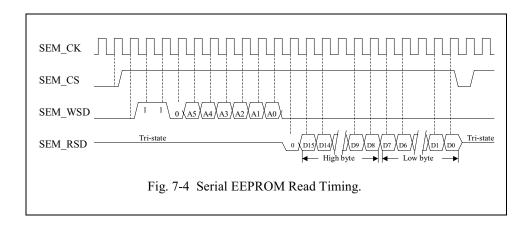
The serial ROM interface is used to access the serial EEPROM as 93C46 type. The vender ID, product ID are pre-stored in and can be read back after the system is power on or after reset action. Figure 7-4 is the read timing of serial ROM interface. The following table is the content description of the serial EEPROM.

Address*	Content	Description
0	iVender / Device Desc, Low-byte.	Vender ID.
1	iVender / Device Desc, High-byte.	Vender ID.
2	iProduct / Device Desc, Low-byte.	Product ID.
3	iProduct / Device Desc, High-byte.	Product ID.
4	bcdDevice / Device Desc, Low-byte.	Device releaseNo. in bcd code.
5	bcdDevice / Device Desc, High-byte.	Device releaseNo. in bcd code.
6	bmAttribute / Configuration Desc.	Bit7: Bus Powered.
		Bit6: Self Powered.
		Bit[5:0]: Reserved.
7	MaxPower / Configuration Desc.	Maximum Power consumption = n x 2 mA.

^{*:} The address is the byte address not the write address of the EEPROM except address 0.

Table 7-1: Content description of EEPROM.





If no serial ROM is used, the SEM_CS, SEM_SK, SEM_WSD and SEM_RSD pins also can be used to select the default vender ID and product ID codes during hardware reset action by connecting these four pins to high, the un-connected pin will be recognized as low state. Any of these four pins driven high will disable serial ROM read action and default vender ID and product ID code will be configured. The following table listed the default vendor/product ID can be selected.

Item	DFT_PDS[3:0]	Vendor/Product ID Code	Description
0	0000		Serial ROM read access.
1	0001	0416/6481	Winbond Vendor/Product ID Code.
2	0010		Vendor/Product ID Code 1.
3	0011		Vendor/Product ID Code 2.
4	0100		Vendor/Product ID Code 3.
5	0101		Vendor/Product ID Code 4.
6	0110		Vendor/Product ID Code 5.
7	0111		Vendor/Product ID Code 6.
8	1000		Vendor/Product ID Code 7.
9	1001		Vendor/Product ID Code 8.
10	1010		Vendor/Product ID Code 9.
11	1011		Vendor/Product ID Code 10.
12	1100		Vendor/Product ID Code 11.
13	1101		Vendor/Product ID Code 12.
14	1110		Vendor/Product ID Code 13.
15	1111		Vendor/Product ID Code 14.

Table 7-2: Default vendor ID and product ID select table.



8. ELECTRICAL CHARACTERISTICS

8.1. Maximum Ratings*

	Parameter	Symbol	Rating	Units
1	Supply Voltage with respect to V _{AVSS} (at AVDD pin)	V _{AVDD}	-0.3 to 6	V
2	Supply Voltage with respect to V _{DVSS} (at DVDD pin)	V_{DVDD}	-0.3 to 6	٧
3	Supply Voltage with respect to V _{DIVSS} (at DIVDD pin)	V_{DIVDD}	-0.3 to 6	V
4	Supply Voltage with respect to V _{UVSS} (at UVDD pin)	V _{UVDD}	-0.3 to 6	V
5	Voltage on any pin other than V _{DVSS} supplies		-0.3 to V _{dd5} + 0.3	V
6	Current at any pin other than supplies		0 to 10	mA
7	Storage Temperature	T _{st}	-65 to 150	$^{\circ}\!\mathbb{C}$

^{*} Exceeding these values may cause permanent damage.

8.2. Recommended Operating Conditions

	Characteristics	Symbol	Rating	Unit
1	Operation Voltage (referenced to AVSS pin).	V _{AVDD}	4.75 to 5.25	V
2	Operation Voltage (referenced to DVSS pin).	V_{DVDD}	4.75 to 5.25	V
3	Operation Voltage (referenced to DIVSS pin).	V_{DIVDD}	3.0 to 3.6	V
4	Operation Voltage (referenced to UVSS pin).	V _{UVDD}	3.0 to 3.6	V
5	Clock Frequency	fXTL	24	MHz
6	Clock Frequency Tolerance	ΔfC	100	PPM
7	Operation Temperature	T _{op}	0 to 70	$^{\circ}\!\mathbb{C}$



8.3. Power Supply Characteristics

	Parameter	Condition	Symbol	Min	Тур‡	Max	Units	Test
1	Standby Supply Current	Power Supply	IQAVDD			0.08	mA	Test 1
2	Operating Supply Current	$(V_{AVDD} = 5.0V)$	lavdd		40	TBD	mA	Test 2

^{‡:} Typical figure are at V_{AVDD} = 5.0V and temperature = 25 $^{\circ}$ C and are for design aid only, not guaranteed and not subject to production testing.

Test 1: Configure as power down mode, no analog input.

Test 2: 24 MHz system clock configured.

	Parameter	Condition	Symbol	Min	Тур‡	Max	Units	Test
1	Standby Supply Current	Power Supply	IQDVDD			0.01	mA	Test 1
2	Operating Supply Current	$(V_{DVDD} = 5.0V)$	IDVDD		5	TBD	mA	Test 2

^{‡:} Typical figure are at V_{DVDD} = 5V and temperature = 25 $^{\circ}$ C and are for design aid only, not guaranteed and not subject to production testing.

Test 1: All input pins are V_{DVDD} or V_{DVSS} , configure as power down mode, output without loading.

Test 2: 24 MHz system clock configured.

	Parameter	Condition	Symbol	Min	Тур‡	Max	Units	Test
1	Standby Supply Current	Power Supply	I _{Q3.3V}			0.05	mA	Test 1
2	Operating Supply Current	$(V_{DIVDD} = 3.3V)$	I _{D3.3V}		40	TBD	mA	Test 2

^{‡:} Typical figure are at V_{DIVDD} = 3.3V and temperature = 25 $^{\circ}$ C and are for design aid only, not guaranteed and not subject to production testing.

Test 1: All input pins are V_{DVDD} or V_{DVSS} , configure as power down mode, output without loading.

Test 2: 24 MHz system clcok configured.



8.4. Digital Characteristics

	Parameter	Condition	Symbol	Min	Тур‡	Max	Units	Notes
1	Output High Voltage	(VDVDD = 5V)	Vон	4.5			V	1
2	Output Low Voltage	(VDVDD = 5V)	VOL			0.5	V	2
3	High Level Input Voltage	(VDVDD = 5V)	V _{IH}	2.5			V	
4	Low Level Input Voltage	(VDVDD = 5V)	V _{IL}			1.4	V	
5	Input Current		lin			1	uA	
6	Input Capacitance		Cin		10		pF	

 $[\]ddagger$: Typical figure are at V_{DVDD} = 5V and temperature = 25 $\,^{\circ}$ C and are for design aid only, not guaranteed and not subject to production testing.

Notes:

- 1: The current must below or equal to the maximum source current as listed in pin descriptions section.
- 2: The current must below or equal to the maximum sink current as listed in pin descriptions section.

8.5. Analog Characteristics (measures from analog input to ADC output)

	Parameter	Symbol	Min	Тур‡	Max	Units	Test Conditions
Ana	log to Digital Converter						
1	Maximum Conversion Rate	SPS		6		MHz	
2	Resolution			16		Bits	
3	Integral Nonlinearity	INL			+/- 8	LSB	
4	Differential Nonlinearity	DNL			+/- 1.5	LSB	



8.5. Analog Characteristics (measures from analog input to ADC output), continued

	Parameter	Symbol	Min	Тур‡	Max	Units	Test Conditions	
PG	PGA & Offset DAC							
1	PGA Gain Range	G	1.0		6.0	V/V		
2	PGA Gain Resolution	G _{RES}		6		bits	Note 1	
3	Offset Range	OFS	-350		+350	mV	V _{AVDD} = 5.0V	
4	DAC bit number			8+sign		bits	Note 1	
5	Offset Resolution	OFS _{RES}		1.36		mV		
Ana	Analog Input and Output							
1	Full Scale of Analog Input	Vin		2.0		V	Note 2	
2	Input Capacitance	Cin		10		pF		
3	Signal to Noise Ratio from analog I/P to ADC O/P	SNR		70		dB	Note 3	

^{‡:} Typical figure are at V_{AVDD} = 5V and temperature = 25 $^{\circ}$ C and are for design aid only, not guaranteed and not subject to production testing.

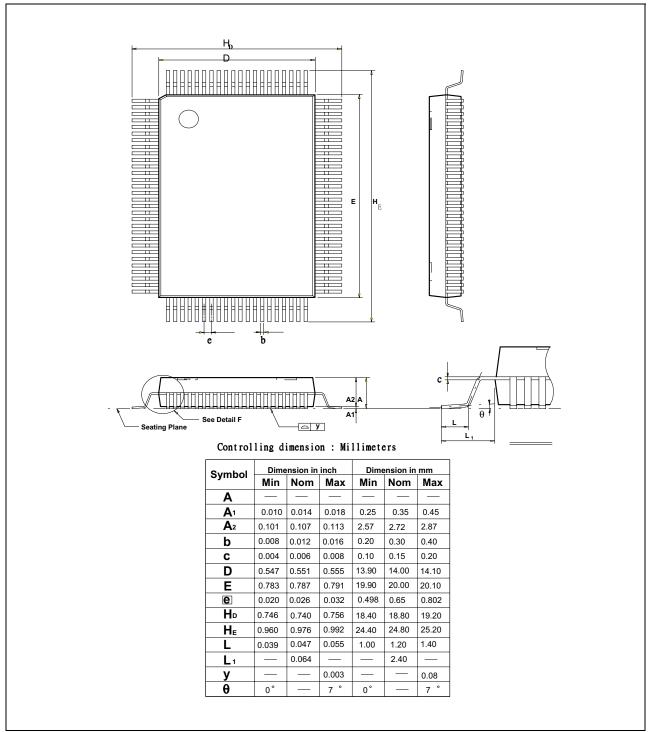
Note:

- 1. All steps of PGA gain and offset are monotonic.
- 2. PGA gain = 1 and offset = 0.
- 3. Analog signal full scale input.



9. PACKAGE INFORMATION (W6668F)

100L QFP(14x20x2.75mm footprint 4.8mm)



Publication Release Date: October 2000



10. HOW TO READ THE TOP MARKING

Example: The top marking of W6668F



1st line: Winbond logo

2nd line: The type number W6668F

3rd line: the tracking code: <u>032 G B 2024923B-91 SA</u>

032: packages made in '00, week 32

G: assembly house ID; 0 means OSE, G means GR

B: IC version

2024923B-91: wafer production series lot number

SA: Internal use code

11. ORDERING INFORMATION

Part Number	Package Type	Production Flow
W6668F	100PQFP	Commercial, 0°C to 70°C





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